

Selection Guide

Part No.	Emitting Color (Material)	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
KCDC02-123	Green (AlGaInP)	White Diffused	3600	12000	Common Cathode, Rt. Hand Decimal.
			*2200	*4300	

Notes:

- Luminous intensity / luminous Flux: +/-15%.
- * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Green	574		nm	I _F =10mA
λ_D [1]	Dominant Wavelength	Green	570		nm	I _F =10mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Green	20		nm	I _F =10mA
C	Capacitance	Green	15		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Green	2.0	2.5	V	I _F =10mA
I _R	Reverse Current	Green		10	uA	V _R =5V

Notes:

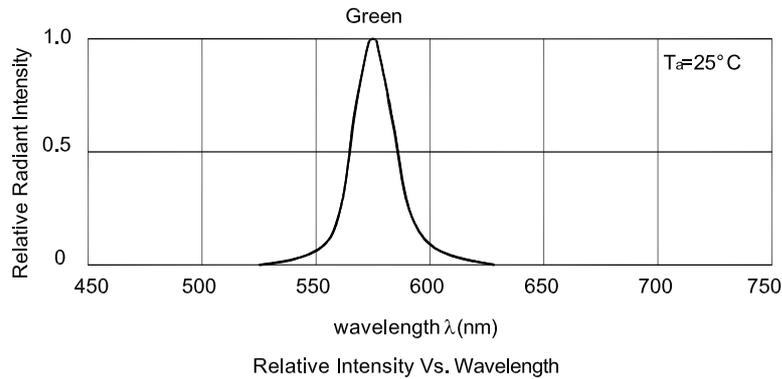
- Wavelength: +/-1nm.
- Forward Voltage: +/-0.1V.
- Wavelength value is traceable to the CIE127-2007 compliant national standards.
- Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	

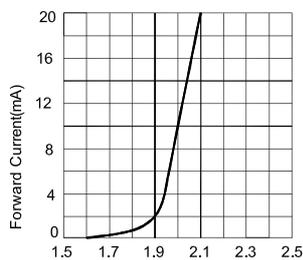
Note:

- 1/10 Duty Cycle, 0.1ms Pulse Width.

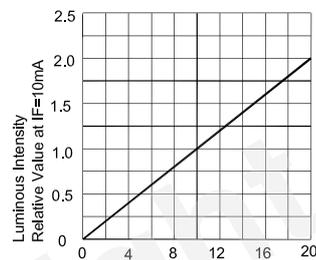


Green

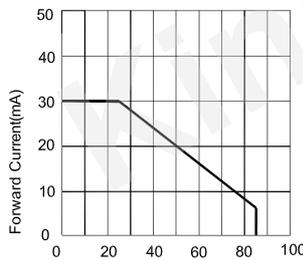
KCDC02-123



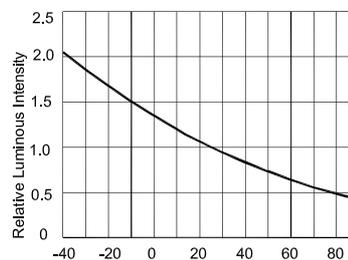
Forward Current Vs.
Forward Voltage



Luminous Intensity Vs.
Forward Current



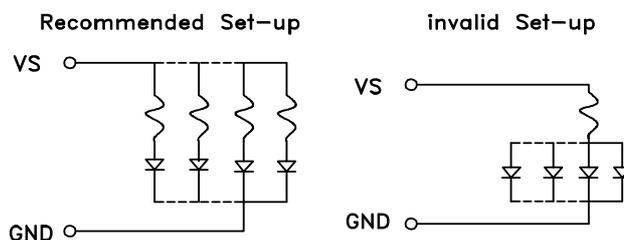
Forward Current
Derating Curve



Luminous Intensity Vs.
Ambient Temperature

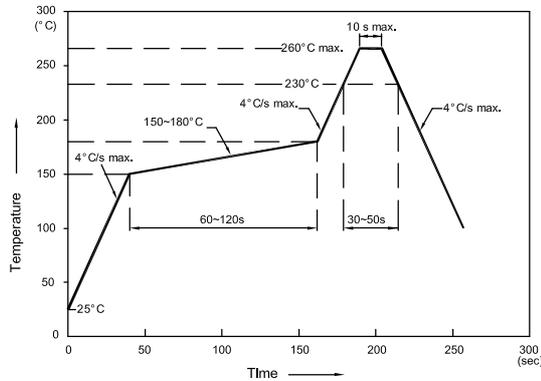
CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



KCDC02-123

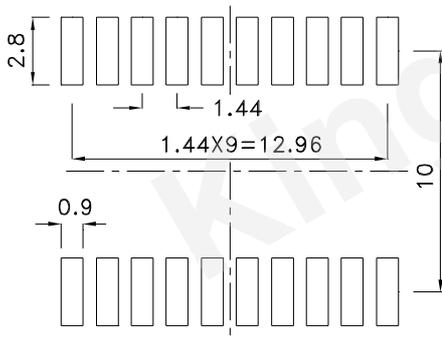
Reflow Soldering Profile For Lead-free SMT Process.



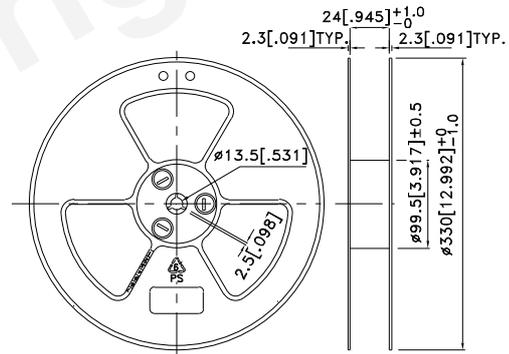
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

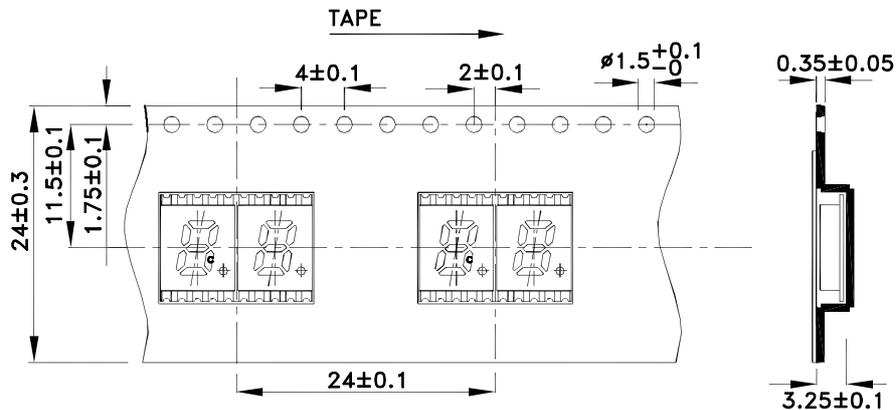
Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.15)



Reel Dimension

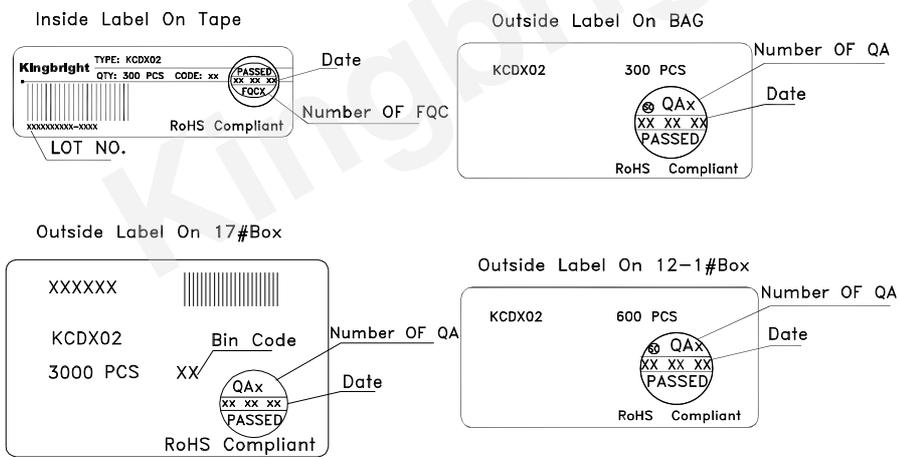
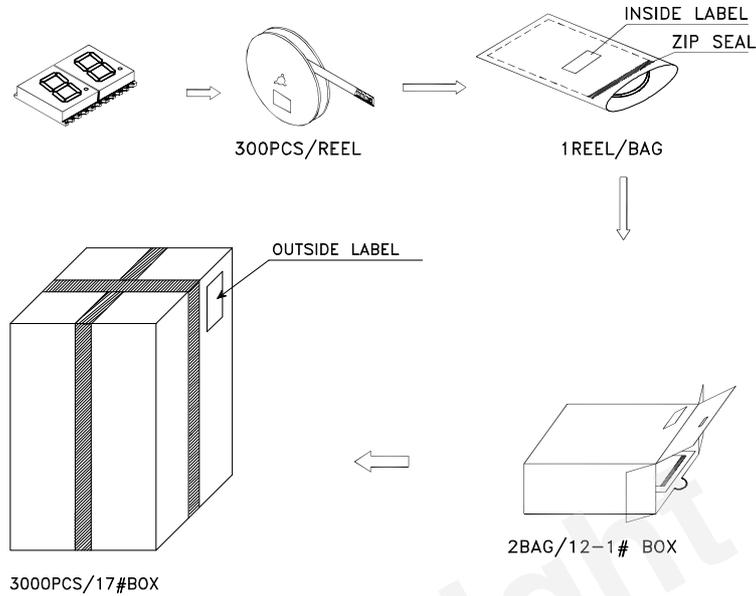


Tape Specifications
(Units : mm)



PACKING & LABEL SPECIFICATIONS

KCDC02-123



Terms and conditions for the usage of this document

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
6. All design applications should refer to Kingbright application notes available at http://www.kingbright.com/application_notes